

ELECTROSTATIC
SENSITIVE
DEVICES



CAUTION

This bag contains

MOISTURE-SENSITIVE DEVICES

LEVEL
3

If Blank, see adjacent
bar code label

1. Calculated shelf life in sealed bag: 12 months at $< 40^{\circ}\text{C}$
and $< 90\%$ relative humidity (RH)
 2. Peak package body temperature: 260 $^{\circ}\text{C}$
If blank, see adjacent bar code label
 3. After bag is opened, devices that will be subjected to reflow
solder or other high temperature process must
a) Mounted within: 168 hours of factory
If blank, see adjacent bar code label
conditions $\leq 30^{\circ}\text{C}/60\%$
b) Stored at $\leq 10\%$ RH
 4. Devices require bake, before mounting, if:
a) Humidity Indicator Card is $> 10\%$ when read at $23 \pm 5^{\circ}\text{C}$
b) 3a or 3b not met
 5. If baking is required, devices may be baked for 48 hours at $125 \pm 5^{\circ}\text{C}$
Note: If device containers cannot be subjected to high temperature
or shorter bake times are desired.
reference IPC/JEDEC J-STD-033 for bake procedure
- Bag Seal Date: _____
If blank, see adjacent bar code label

Note: Level and body temperature defined by IPC/JEDEC J-STD-020



平芯微®

Wuxi PWCHIP Semi Technology CO., LTD

Product: PW3130



Lot No: 夸克微科技



D/C: 2405

Data:

2024/01/30

QTY: 3000

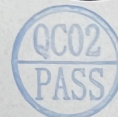


无锡市平芯微半导体科技有限公司

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ROHS



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